

# APPROVAL SHEET

## RFDIP Series - 2012(0805)- RoHS Compliance

### **MULTILAYER CERAMIC DIPLEXER**

**Halogens Free Product** 

2.4 GHz & 5 GHz ISM Band RF Application

P/N: KFDIP2004L41B7B1U

\*Contents in this sheet are subject to change without prior notice.



#### **FEATURES**

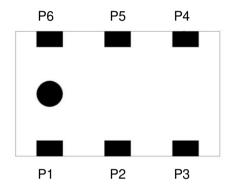
- 1. Miniature footprint: 2.0 X 1.25 X 0.4 mm<sup>3</sup>.
- 2. Low Insertion Loss
- 3. High Rejection Rate
- 4. LTCC Process

#### **APPLICATIONS**

1. 2400 ~ 2500 MHz and 4900 ~ 5950 MHz working frequency

#### CONSTRUCTION

Top view



PIN	N Connection		Connection
1	GND	4	Lower Freq. Port
2	Common(ANT) Port	5	GND
3	GND	6	Higher Freq. Port

#### **DIMENSIONS**

	Figure	Symbol	Dimension (mm)
W	Ет	L	2.00 ± 0.15
	A	W	1.25 ± 0.15
		Т	0.40 ± 0.10
_ ■ ■		А	0.20 ± 0.20
		В	0.30 ± 0.20
•		С	0.35 ± 0.20
Top view	Bottom view Side view	D	0.65 ± 0.20
		E	0.20 ± 0.15



#### **ELECTRICAL CHARACTERISTICS**

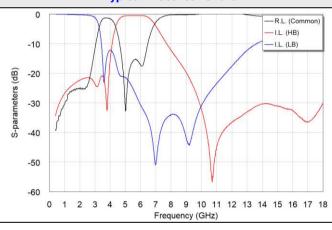
KFDIP2004L41B7B1U	Specif	ication		
Frequency range	2400 ~ 2500 MHz	4900 ~ 5950 MHz		
Insertion Loss	0.5 dB max. at 25°C 0.65 dB max. at -40 $\sim$ +85°C	1.0 dB max. at 25°C 1.2 dB max. at -40 ~ +85°C		
Attenuation	10 dB min. @ 3600 MHz 20 dB min. @ 4800 ~ 5000 MHz 20 dB min. @ 7200 ~ 7500 MHz	20 dB min. @ 824 ~ 915 MHz 20 dB min. @ 1800 ~ 2500 MHz 10 dB min. @ 3000 ~ 3400 MHz 20 dB min. @ 3400 ~ 3600 MHz 10 dB min. @ 3600 ~ 3900 MHz 4 dB min. @ 7250 MHz 20 dB min. @ 9800 ~ 11900 MHz 20 dB min. @ 14700 ~ 17850 MHz		
Isolation	20 dB min. @ DC ~ 2500 MHz 20 dB min. @ 4900 ~ 5950 MHz			
VSWR	2.0 max.			
Impedance	50Ω			
Power capacity	2W max			
Moisture sensitivity levels  Operating & Storage Condition		LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)		

Operating & Storage Condition (Component)
Operation Temperature Range: -40 ~ +85 °C

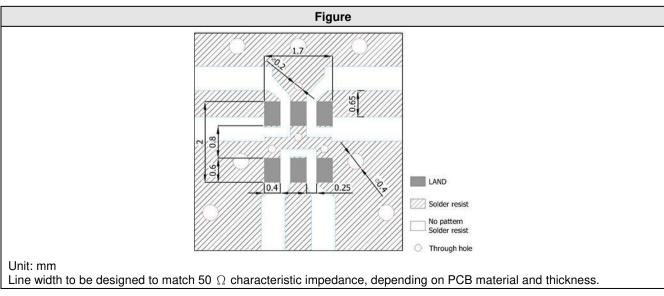
## Storage Temperature Range: -40 ~ +85 ℃ Storage Condition before Soldering (Included packaging material)

Storage Temperature Range:  $+5 \sim +40 ^{\circ}$ C Humidity: 30 to 70% relative humidity

#### **Typical Electrical Chart**



#### **LAND PATTERN**





#### **RELIABILITY TEST**

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature : 235 $\pm$ 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : $2 \pm 0.5$ sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder: Sn3Ag0.5Cu for lead-free	
Resistance to soldering heat	*Preheating temperature: 120~150°C,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
		~ 85°C.
	Solder : Sn3Ag0.5Cu for lead-free	Loss of metallization on the edges of each
	Measurement to be made after keeping at	electrode shall not exceed 25%.
	room temperature for 24±2 hrs	
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044	*Test Surface: Rigid surface of concrete or	Electrical specification shall satisfy the
Customer's specification.	steel.	descriptions in electrical characteristics under
	*Times: 6 surfaces for each units; 2 times	the operational temperature range within -40
	for each side.	~ 85°C.
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude: 1.5mm	Electrical specification shall satisfy the
	*Test times : 6hrs.(Two hrs each in three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
	, , , , , , , , , , , , , , , , , , , ,	~ 85°C.
Adhesive Strength	*Pressurizing force :	No remarkable damage or removal of the
of Termination	5N ( LGA terminal series ) ;5N(≦0603) ;	termination.
JIS C 0051- 7.4.3	10N(>0603)	
	*Test time: 10±1 sec	
Bending test	The middle part of substrate shall be	No mechanical damage.
JIS C 0051- 7.4.1	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	

Temperature cycle JIS C 0025	<ol> <li>30±3 minutes at -40°C±3°C,</li> <li>10~15 minutes at room temperature,</li> <li>30±3 minutes at +85°C±3°C,</li> <li>10~15 minutes at room temperature,</li> <li>Total 100 continuous cycles</li> <li>Measurement to be made after keeping at room temperature for 24±2 hrs</li> </ol>	No mechanical damage.  Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021	*Temperature: 85°C±2°C  *Test duration: 1000+24/-0 hours  Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage.  Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Humidity (steady conditions) JIS C 0022	*Humidity: 90% to 95% R.H.  *Temperature: 40±2°C  *Time: 1000+24/-0 hrs.  Measurement to be made after keeping at room temperature for 24±2 hrs  % 500hrs measuring the first data then 1000hrs data	No mechanical damage.  Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
JIS C 0020	*Temperature : -40°C±2°C  *Test duration : 1000+24/-0 hours  Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage.  Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.



#### **SOLDERING CONDITION**

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

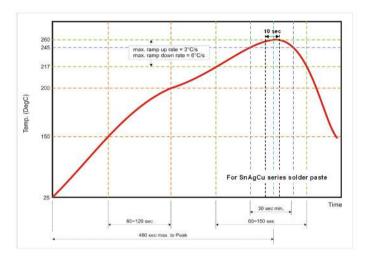


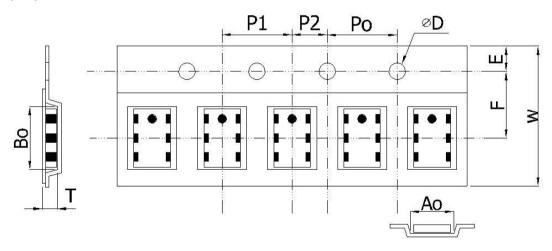
Fig 2. Infrared soldering profile

#### **ORDERING CODE**

KF	DIP	20	04	L	41B	Т
Walsin	Product	Dimension code	Dimension	Application	Specification	Packing
RF	Code	Per 2 digits of Length,	code	L :	Design code	T : Reeled
device	DIP:	Width,:	04=	2.4GHz/5GHz		
	Diplexer	e.g. :	Thickness 04			
		20 =				
		Length 20,				
		Width 12,				

Minimum Ordering Quantity: 2000 pcs per reel.

#### **PACKAGING**

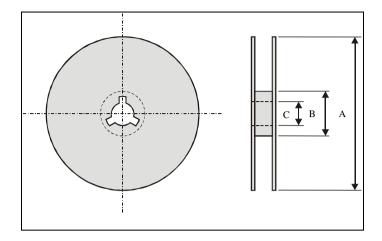


#### Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	$1.40 \pm 0.10$	$2.25 \pm 0.10$	$1.55 \pm 0.05$	$0.75 \pm 0.10$	$8.0 \pm 0.10$
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	$3.50 \pm 0.05$	$4.00 \pm 0.10$	$4.00 \pm 0.10$	$2.00\pm0.05$



#### **Reel dimensions**



Index	Α	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity:2000 pieces per 7" reel

#### **CAUTION OF HANDLING**

#### **Limitation of Applications**

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

#### Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
  - Products should be storage in the warehouse on the following conditions.

Temperature : +5 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.